STRENGTH OF CERAMIC SUBSTRATES FOR PIEZORESISTIVE THICK-FILM SENSOR APPLICATIONS

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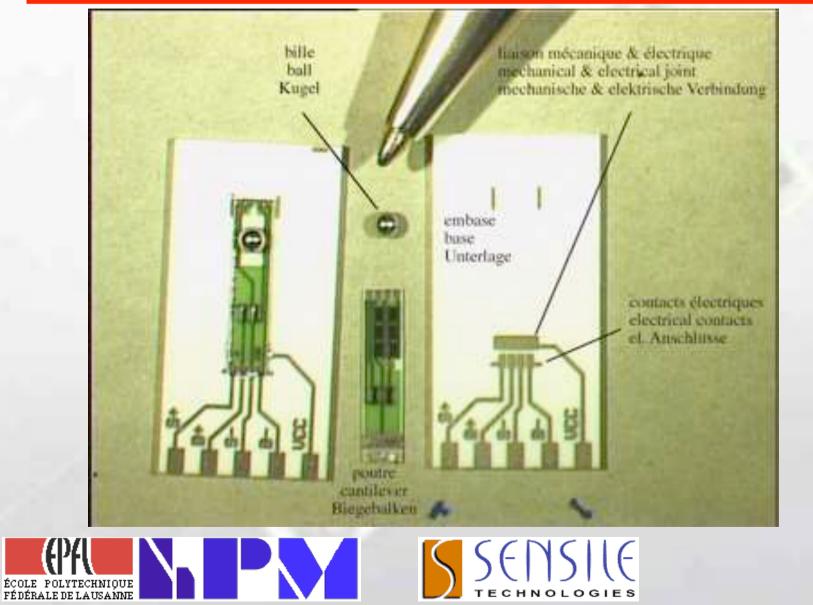
1. Sensile Technologies, Lausanne, Switzerland, www.sensile.com

2. EPFL-LPM, Lausanne, Switzerland, lpm.epfl.ch



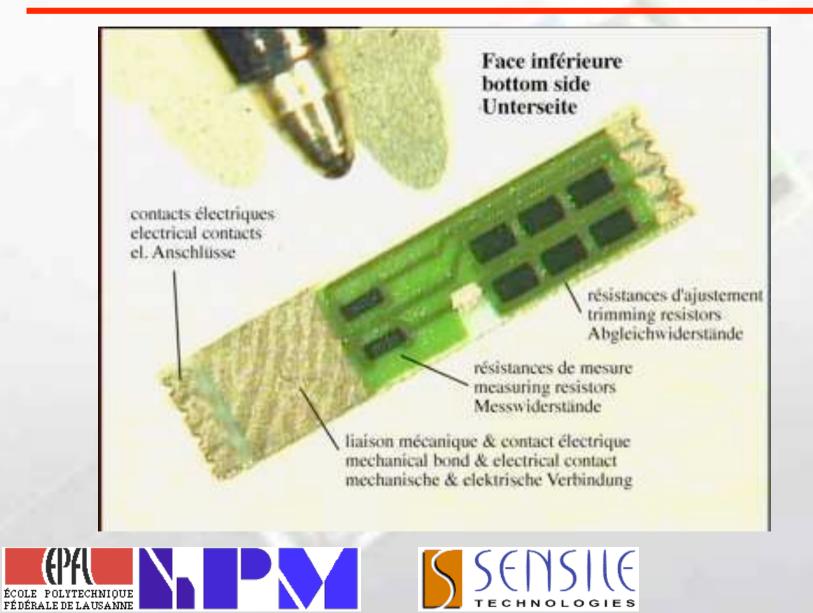


Principle: a simple force cell





Alumina cantilever



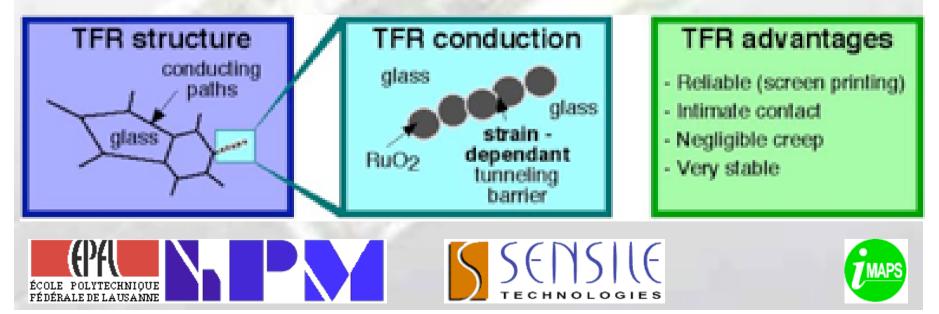


Piezoresistive thick-film sensors

Thick-film resistors posess a piezoresistive effect.

Gauge factor = rel. variation / strain = ($\Delta R/R$) / ϵ

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The gauge factor is typ. 12.
(Si : 50)
(metal DMS - Dehnmessstreifen : 2)
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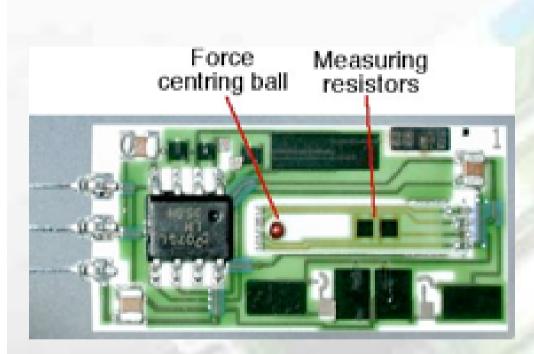
Product: force sensor

Soldered alumina cantilever beam





Product: force sensor



Stressed films

- 1. Terminations / conductor lines.
- 2. Measuring resistors.
- 3. Protective glass.





Improving sensor response?

- **1. Resistive composition**. High gauge factor compositions have problems...
- 2. Strain (substrate). Needs better material than alumina!
- 3. Strain (films). May also need better materials!





Candidate ceramic materials

- 1. High-purity alumina: slight improvement.
- 2. Zirconia: potentially the best.
- **3. ZTA**: $Al_2O_3 + ZrO_2$: strong & close to alumina.
- 4. LTCC? Not high strength, but other advantages (integration & shape).





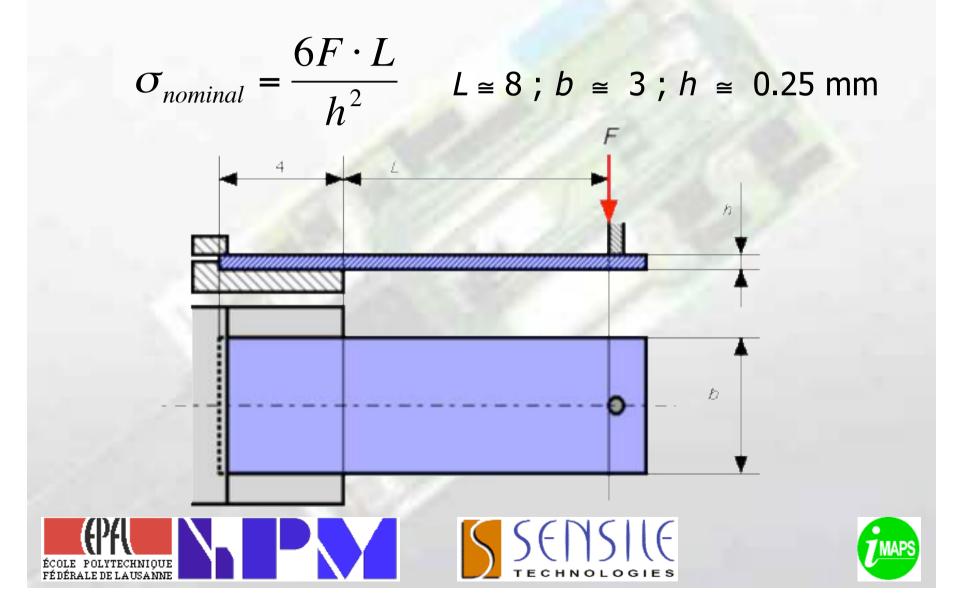
Issues with ceramics

- Chemical reactions with thick-film pastes?
- Strain limited by paste failure?
- Thermal expansion stress and TCR.
- Weakening of substrate by thick-films:
 only tensile stresses really count...
- Weakening by firing schedule: metals, ZrO₂?



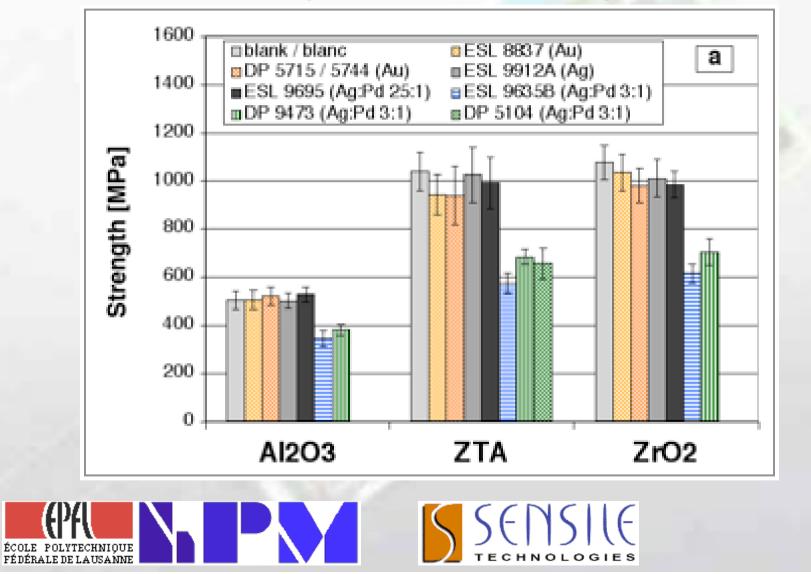


Test setup: long & short-term



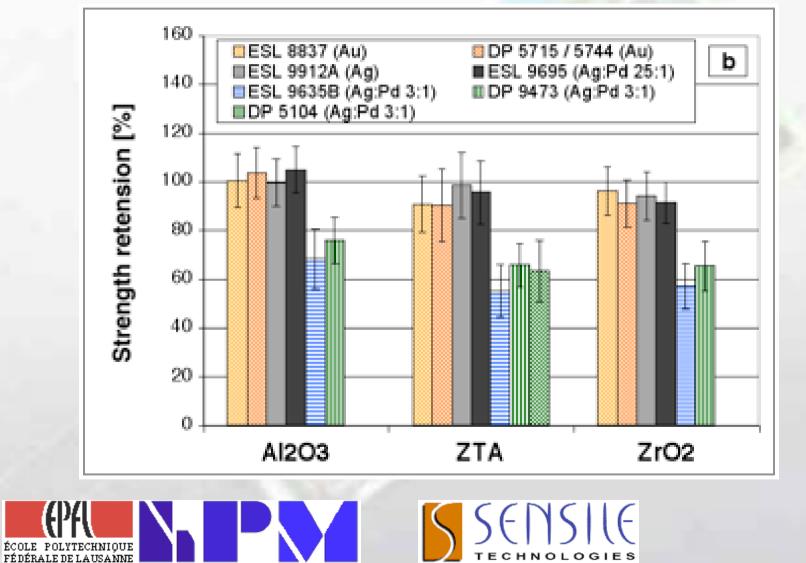
Effect of metals on strength

(Short-term, absolute)



Effect of metals on strength







Effect of conductors

 Conductors with little or no glass frit: retention of original strength

Ag, Ag:(Pd+Pt) 25:1, Au, thin Au

• Conductors with high glass frit: significant loss in strength (25...45%)

Ag:Pd 2:1...4:1







Effect of conductors: glass frit

Local tensile stresses

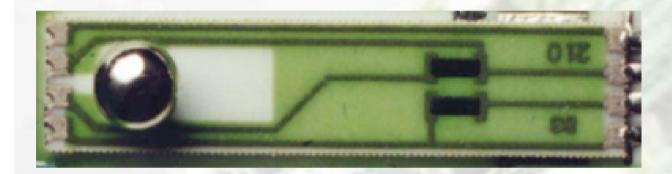
Substrate grain boundaries



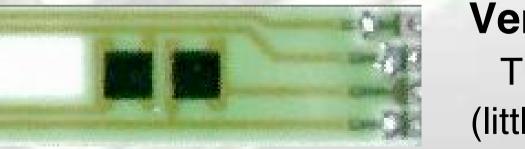


Design of load cell

⇒ Replacement of Ag:Pd 3:1 by thin Au



Version 1 Ag:Pd 3:1 (& glass)



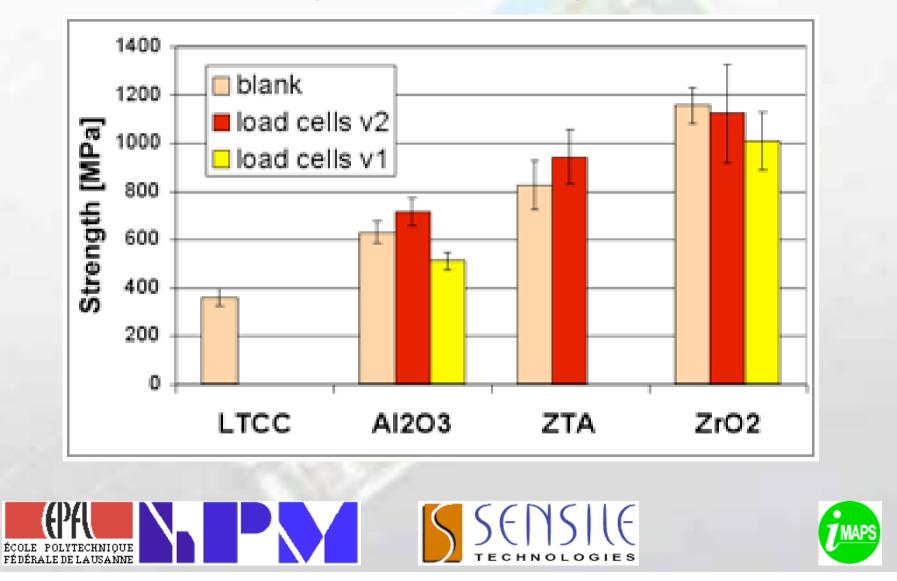






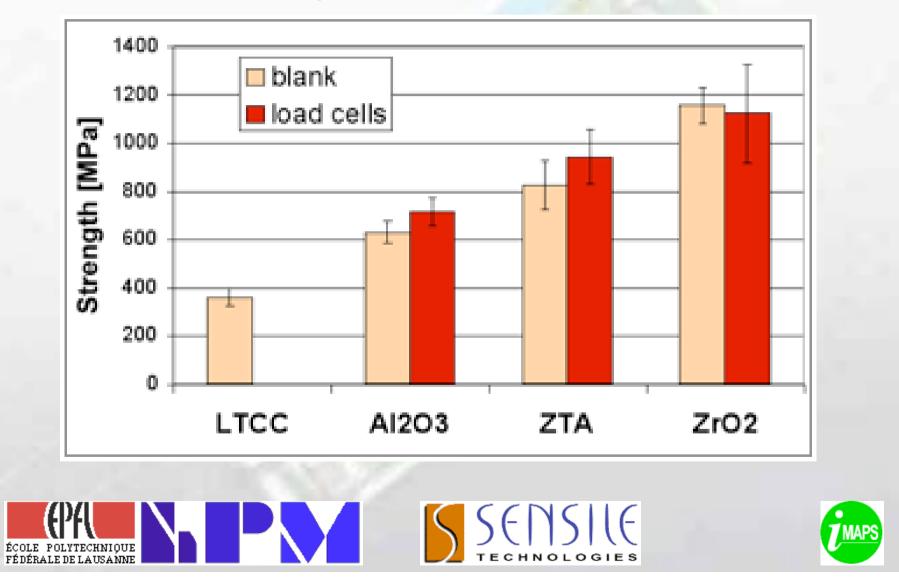
Blank and screen-printed

(Short-term, stress)



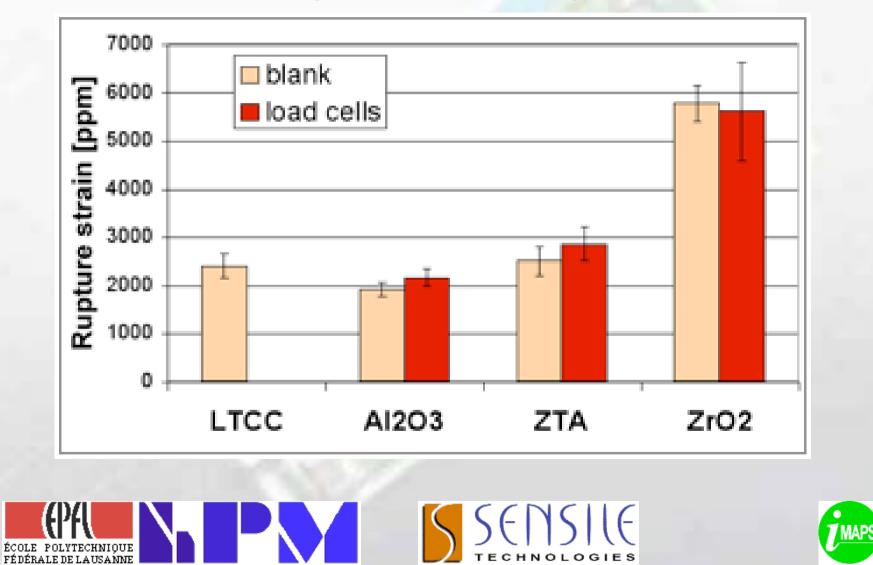
Blank and screen-printed

(Short-term, stress)



Blank and screen-printed

(Short-term, strain)



Summary: short-term results

- ZrO₂ gives potentially the highest signal, but also some problems: TCR shift, low thermal conductivity, and cost.
- ZTA is a « drop-in » improvement over Al_2O_3 .
- LTCC (Du Pont 951) compares favourably with Al_2O_3 .





Long-term strength

- Subcritical crack growth occurs until rupture (static fatigue).
- Stress time to rupture : Paris' law.

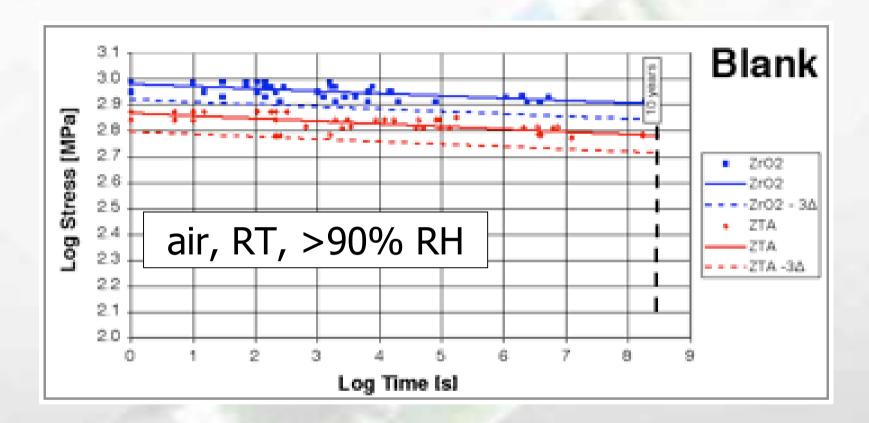
$$\sigma = \sigma_0 \cdot \left(\frac{t}{t_0}\right)^{-1/n} \qquad \log \sigma = \log \sigma_0 - \frac{1}{n} \log \left(\frac{t}{t_0}\right)$$

• The value of *n* is a quality indicator.





Long-term strength - blank

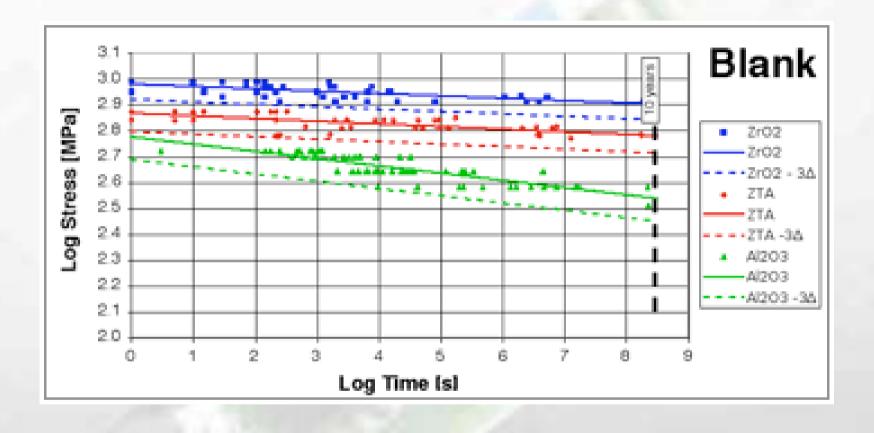


 \Rightarrow ZrO₂ & ZTA exhibit very small static fatigue





Long-term strength - blank

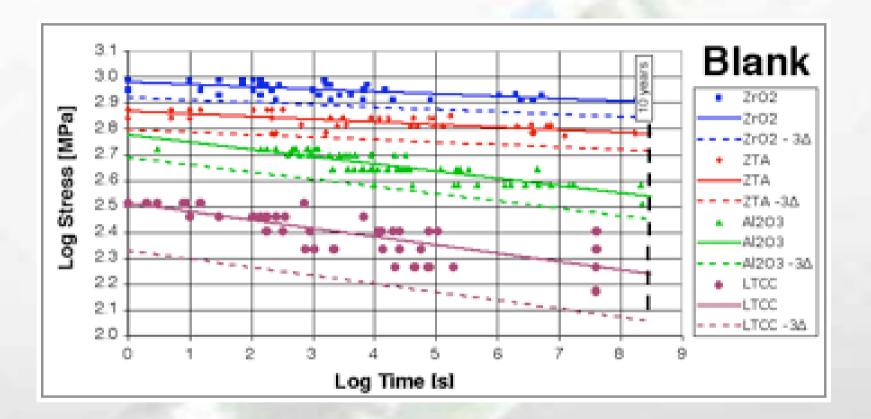


 \Rightarrow 96% Al₂O₃ : glassy grain boundary phase





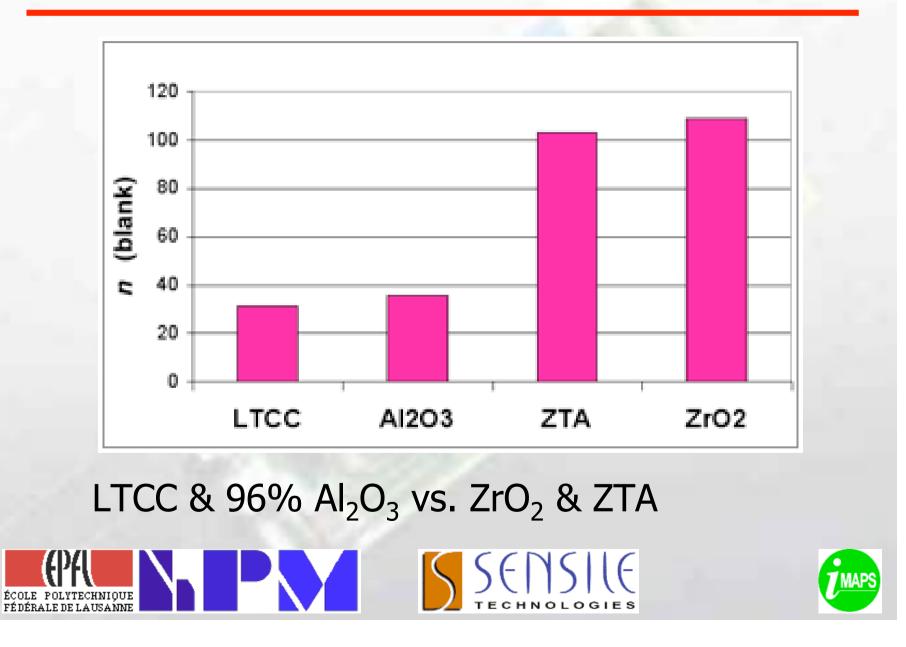
Long-term strength - blank



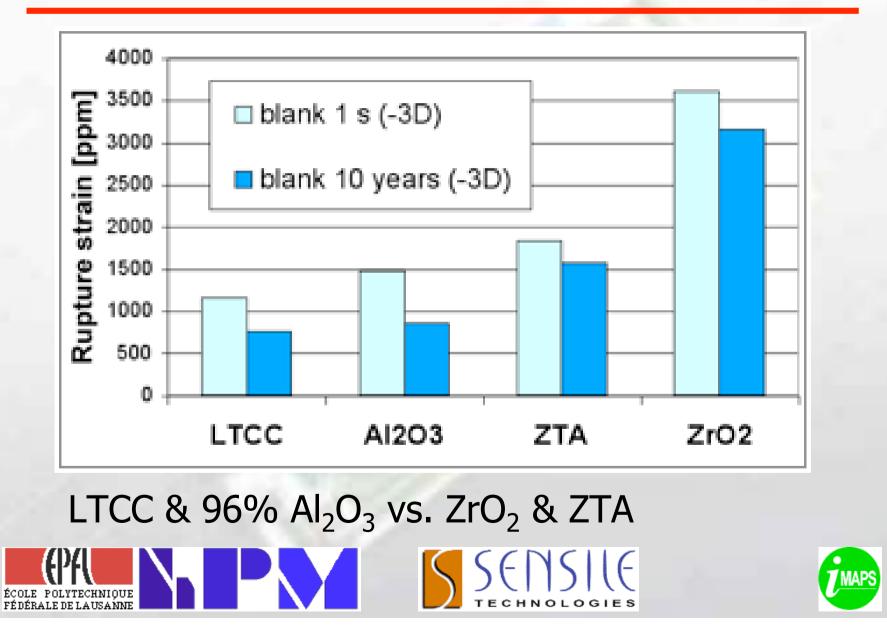
 \Rightarrow LTCC behaviour similar to Al₂O₃ : glassy

ÉCOLE POLYTECHNIQUE FÉDÉRALE DE LAUSANNE

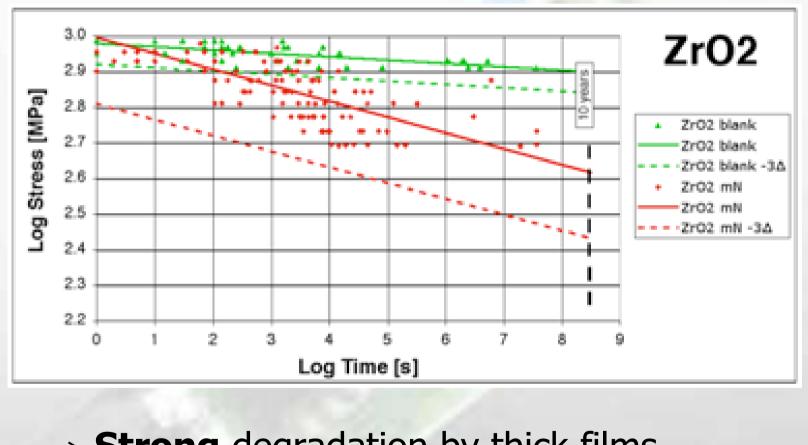
Long-term : n values - blank



Long-term strain (blank, -3D)



Long-term strength : load cells

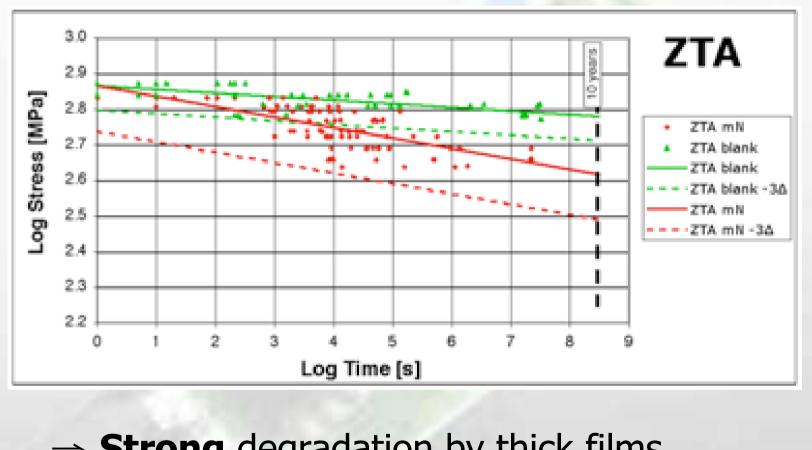


⇒ **Strong** degradation by thick films





Long-term strength : load cells

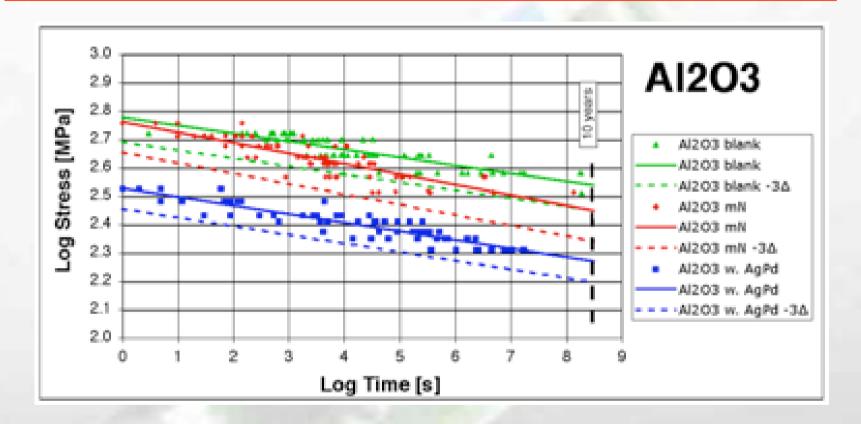


 \Rightarrow **Strong** degradation by thick films





Long-term strength : load cells

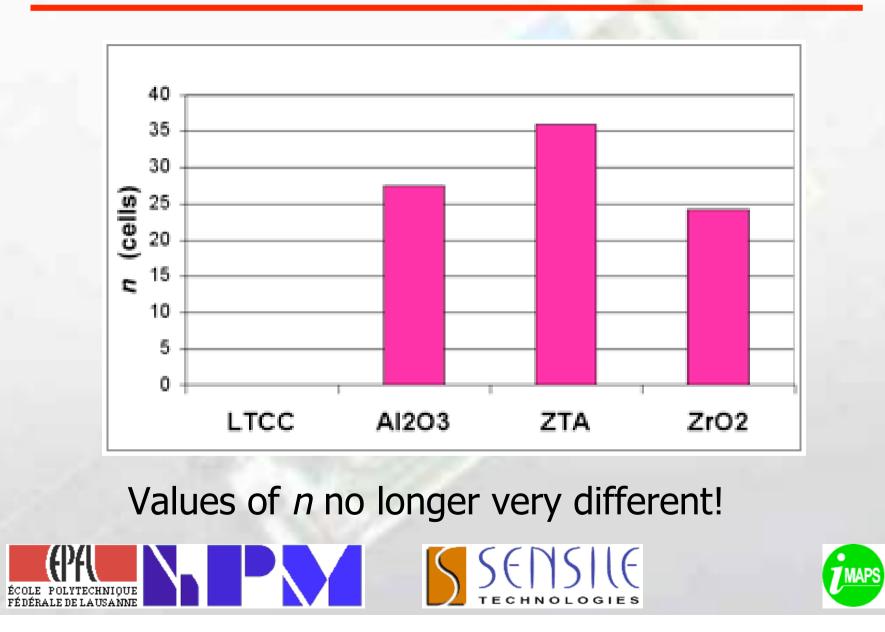


⇒ Little degradation by « good » thick films



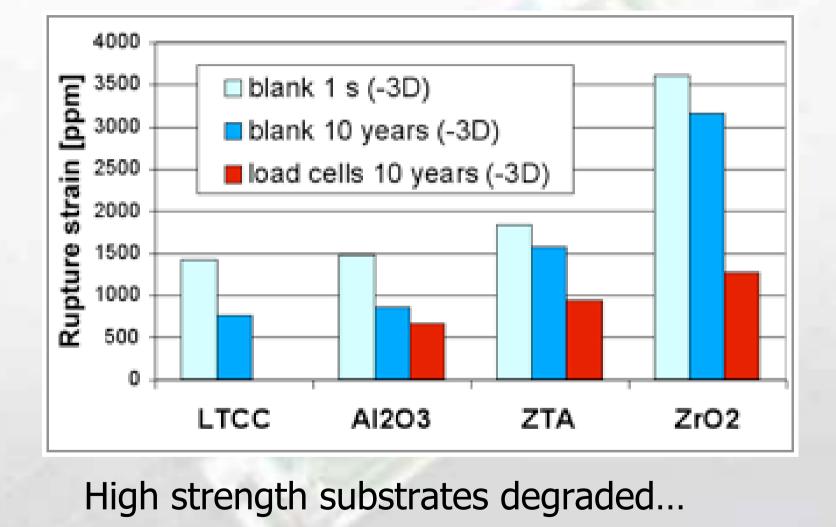


Long-term : n values - load cells



2003 Maeder IMAPS strength 30

Long-term strain (load cells, -3D)







Conclusions

- LTCC promising, $\approx Al_2O_3 96\%$
- No degradation of short-term strength with « good » thick-film system
- Long-term severely degraded on highstrength substrates
- Suitable thick film systems must be introduced!







THANK

YOU!



